8-stage shift-and-store bus register Rev. 6 — 31 December 2012

Product data sheet

1. General description

The 74HC4094; 74HCT4094 is an 8-bit serial-in/serial or parallel-out shift register with a storage register and 3-state outputs. Both the shift and storage register have separate clocks. The device features a serial input (D) and two serial outputs (QS1 and QS2) to enable cascading. Data is shifted on the LOW-to-HIGH transitions of the CP input. Data is available at QS1 on the LOW-to-HIGH transitions of the CP input to allow cascading when clock edges are fast. The same data is available at QS2 on the next HIGH-to-LOW transition of the CP input to allow cascading when clock edges are slow. The data in the shift register is transferred to the storage register when the STR input is HIGH. Data in the storage register appears at the outputs whenever the output enable input (OE) is HIGH. A LOW on OE causes the outputs to assume a high-impedance OFF-state. Operation of the OE input does not affect the state of the registers. Inputs include clamp diodes. This enables the use of current limiting resistors to interface inputs to voltages in excess of V_{CC} .

2. Features and benefits

- Complies with JEDEC standard JESD7A
- Input levels:
 - For 74HC4094: CMOS level
 - ◆ For 74HCT4094: TTL level
- Low-power dissipation
- ESD protection:
 - ◆ HBM JESD22-A114F exceeds 2 000 V
 - MM JESD22-A115-A exceeds 200 V
- Specified from –40 °C to +85 °C and from –40 °C to +125 °C

3. Applications

- Serial-to-parallel data conversion
- Remote control holding register

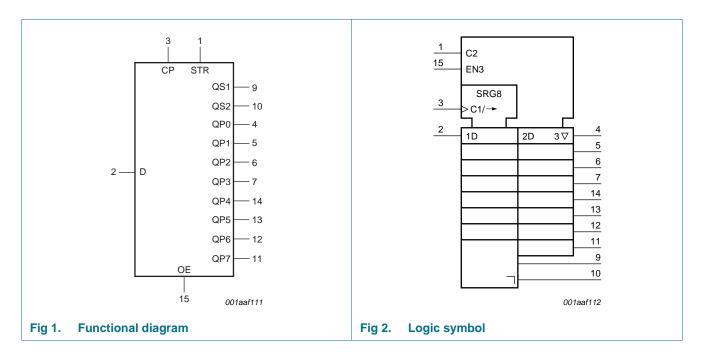


8-stage shift-and-store bus register

Ordering information 4.

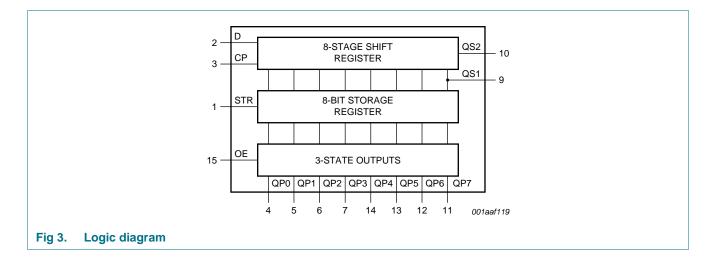
| Table 1. Orde | ering information | | | |
|---------------|-------------------|---------|---|----------|
| Type number | Package | | | |
| | Temperature range | Name | Description | Version |
| 74HC4094N | –40 °C to +125 °C | DIP16 | plastic dual in-line package; 16 leads (300 mil) | SOT38-4 |
| 74HCT4094N | | | | |
| 74HC4094D | –40 °C to +125 °C | SO16 | plastic small outline package; 16 leads; body width | SOT109-1 |
| 74HCT4094D | | | 3.9 mm | |
| 74HC4094DB | –40 °C to +125 °C | SSOP16 | plastic shrink small outline package; 16 leads; | SOT338-1 |
| 74HCT4094DB | | | body width 5.3 mm | |
| 74HC4094PW | –40 °C to +125 °C | TSSOP16 | plastic thin shrink small outline package; 16 leads; body width 4.4 mm | SOT403-1 |

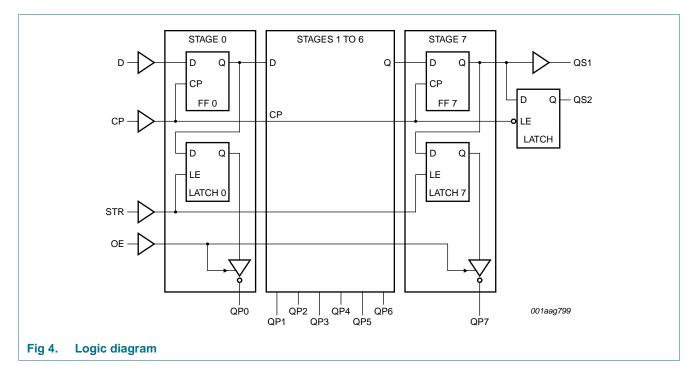
Functional diagram 5.



74HC4094; 74HCT4094

8-stage shift-and-store bus register

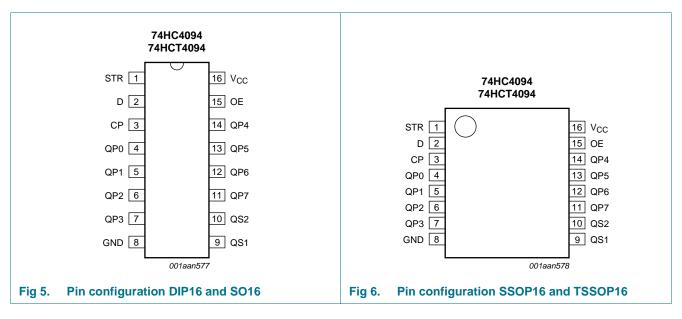




8-stage shift-and-store bus register

6. Pinning information

6.1 Pinning



6.2 Pin description

| Table 2. | Pin description | |
|-----------------|------------------------------|-----------------------|
| Symbol | Pin | Description |
| STR | 1 | strobe input |
| D | 2 | data input |
| СР | 3 | clock input |
| QP0 to QP | 7 4, 5, 6, 7, 14, 13, 12, 11 | parallel output |
| V _{SS} | 8 | ground supply voltage |
| QS1, QS2 | 9, 10 | serial output |
| OE | 15 | output enable input |
| V _{DD} | 16 | supply voltage |

8-stage shift-and-store bus register

7. Functional description

Table 3.Function table

| Inputs | | | | Parallel o | outputs | Serial outputs | | |
|--------------|----|-----|---|------------|---------|----------------|-----|--|
| СР | OE | STR | D | QP0 | QPn | QS1 | QS2 | |
| \uparrow | L | х | Х | Z | Z | Q6S | NC | |
| \downarrow | L | Х | Х | Z | Z | NC | Q7S | |
| ↑ | Н | L | Х | NC | NC | Q6S | NC | |
| \uparrow | Н | Н | L | L | QPn –1 | Q6S | NC | |
| ↑ | Н | Н | Н | Н | QPn –1 | Q6S | NC | |
| \downarrow | Н | Н | Н | NC | NC | NC | Q7S | |

[1] At the positive clock edge, the information in the 7th register stage is transferred to the 8th register stage and the QSn outputs.

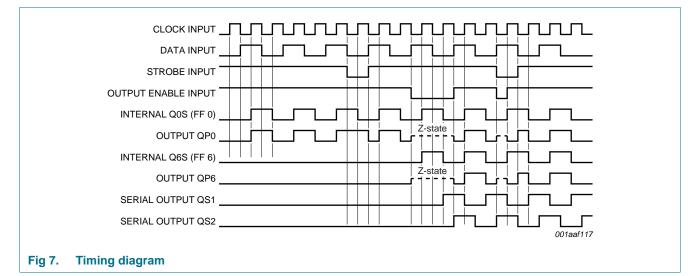
H = HIGH voltage level; L = LOW voltage level; X = don't care;

 \uparrow = positive-going transition; \downarrow = negative-going transition;

Z = HIGH-impedance OFF-state; NC = no change;

Q6S = the data in register stage 6 before the LOW to HIGH clock transition;

Q7S = the data in register stage 7 before the HIGH to LOW clock transition.



8-stage shift-and-store bus register

8. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|------------------|-------------------------|--|--------------|------|------|
| V _{CC} | supply voltage | | -0.5 | +7 | V |
| I _{IK} | input clamping current | $V_{\rm I} < -0.5$ V or $V_{\rm I} > V_{\rm CC}$ + 0.5 V | - | ±20 | mA |
| I _{OK} | output clamping current | $V_{\rm O}$ < –0.5 V or $V_{\rm O}$ > $V_{\rm CC}$ + 0.5 V | - | ±20 | mA |
| lo | output current | $V_{O} = -0.5 \text{ V to} (V_{CC} + 0.5 \text{ V})$ | - | ±25 | mA |
| I _{CC} | supply current | | - | +50 | mA |
| I _{GND} | ground current | | - | -50 | mA |
| T _{stg} | storage temperature | | -65 | +150 | °C |
| P _{tot} | total power dissipation | DIP16 package | <u>[1]</u> _ | 750 | mW |
| | | SO16, SSOP16 and TSSOP16 packages | [2] _ | 500 | mW |
| | | | | | |

[1] For DIP16 package: P_{tot} derates linearly with 12 mW/K above 70 $^\circ\text{C}.$

[2] For SO16: P_{tot} derates linearly with 8 mW/K above 70 $^\circ\text{C}.$

For SSOP16 and TSSOP16 packages: Ptot derates linearly with 5.5 mW/K above 60 °C.

9. Recommended operating conditions

Table 5. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V)

| Symbol | Parameter | Conditions | 74HC | 4094 | | 74HC | Г4094 | | Unit |
|-----------------------|-------------------------------------|------------------|------|------|----------|------|-------|-----------------|------|
| | | | Min | Тур | Max | Min | Тур | Max | |
| V _{CC} | supply voltage | | 2.0 | 5.0 | 6.0 | 4.5 | 5.0 | 5.5 | V |
| VI | input voltage | | 0 | - | V_{CC} | 0 | - | V _{CC} | V |
| Vo | output voltage | | 0 | - | V_{CC} | 0 | - | V _{CC} | V |
| T _{amb} | ambient temperature | | -40 | +25 | +125 | -40 | +25 | +125 | °C |
| $\Delta t / \Delta V$ | input transition rise and fall rate | $V_{CC} = 2.0 V$ | - | - | 625 | - | - | - | ns/V |
| | | V_{CC} = 4.5 V | - | 1.67 | 139 | - | 1.67 | 139 | ns/V |
| | | $V_{CC} = 6.0 V$ | - | - | 83 | - | - | - | ns/V |

8-stage shift-and-store bus register

10. Static characteristics

Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | | 25 °C | | –40 °C t | o +85 °C | –40 °C to | o +125 ℃ | Uni |
|-----------------|-----------------------------|--|------|-------|------|----------|----------|-----------|----------|-----|
| | | | Min | Тур | Max | Min | Max | Min | Max | |
| 74HC40 | 94 | | | | | | 1 | | | |
| V _{IH} | HIGH-level | V _{CC} = 2.0 V | 1.5 | 1.2 | - | 1.5 | - | 1.5 | - | V |
| | input voltage | $V_{CC} = 4.5 V$ | 3.15 | 2.4 | - | 3.15 | - | 3.15 | - | V |
| | | $V_{CC} = 6.0 V$ | 4.2 | 3.2 | - | 4.2 | - | 4.2 | - | V |
| VIL | LOW-level | $V_{CC} = 2.0 V$ | - | 0.8 | 0.5 | - | 0.5 | - | 0.5 | V |
| | input voltage | $V_{CC} = 4.5 V$ | - | 2.1 | 1.35 | - | 1.35 | - | 1.35 | V |
| | | $V_{CC} = 6.0 V$ | - | 2.8 | 1.8 | - | 1.8 | - | 1.8 | V |
| √ _{ОН} | HIGH-level | $V_{I} = V_{IH} \text{ or } V_{IL}$ | | | | | | | | |
| | output voltage | I_{O} = -20 μ A; V_{CC} = 2.0 V | 1.9 | 2.0 | - | 1.9 | - | 1.9 | - | V |
| | | I_O = -20 μ A; V_{CC} = 4.5 V | 4.4 | 4.5 | - | 4.4 | - | 4.4 | - | V |
| | | I_{O} = -20 μ A; V_{CC} = 6.0 V | 5.9 | 6.0 | - | 5.9 | - | 5.9 | - | V |
| | | I_{O} = -4.0 mA; V_{CC} = 4.5 V | 3.98 | 4.32 | - | 3.84 | - | 3.7 | - | V |
| | | I_{O} = -5.2 mA; V_{CC} = 6.0 V | 5.48 | 5.81 | - | 5.34 | - | 5.2 | - | V |
| √ _{OL} | LOW-level | $V_I = V_{IH} \text{ or } V_{IL}$ | | | | | | | | |
| | output voltage | $I_0 = 20 \ \mu A; \ V_{CC} = 2.0 \ V$ | - | 0 | 0.1 | - | 0.1 | - | 0.1 | V |
| | | $I_0 = 20 \ \mu A; V_{CC} = 4.5 \ V$ | - | 0 | 0.1 | - | 0.1 | - | 0.1 | V |
| | | $I_{O} = 20 \ \mu A; V_{CC} = 6.0 \ V$ | - | 0 | 0.1 | - | 0.1 | - | 0.1 | V |
| | | I_{O} = 4.0 mA; V_{CC} = 4.5 V | - | 0.15 | 0.26 | - | 0.33 | - | 0.4 | V |
| | | $I_{O} = 5.2 \text{ mA}; V_{CC} = 6.0 \text{ V}$ | - | 0.16 | 0.26 | - | 0.33 | - | 0.4 | V |
| I | input leakage current | $V_{I} = V_{CC} \text{ or GND};$ $V_{CC} = 6.0 \text{ V}$ | - | - | ±0.1 | - | ±1.0 | - | ±1.0 | μA |
| OZ | OFF-state output current | | - | - | ±0.5 | - | ±5.0 | - | ±10.0 | μA |
| СС | supply current | | - | - | 8.0 | - | 80 | - | 160 | μA |
| CI | input capacitance | | - | 3.5 | - | | | | | pF |
| 74HCT4 | 094 | | | | | | | | | |
| VIH | HIGH-level input voltage | V_{CC} = 4.5 V to 5.5 V | 2.0 | 1.6 | - | 2.0 | - | 2.0 | - | V |
| V _{IL} | LOW-level input voltage | V_{CC} = 4.5 V to 5.5 V | - | 1.2 | 0.8 | - | 0.8 | - | 0.8 | V |
| / _{ОН} | HIGH-level | $V_{I} = V_{IH} \text{ or } V_{IL}; V_{CC} = 4.5 \text{ V}$ | | | | | | | | |
| | output voltage | I _O = -20 μA | 4.4 | 4.5 | - | 4.4 | - | 4.4 | - | V |
| | | I _O = -4.0 mA | 3.98 | 4.32 | - | 3.84 | - | 3.7 | - | V |
| √ _{OL} | LOW-level | $V_{I} = V_{IH} \text{ or } V_{IL}; V_{CC} = 4.5 \text{ V}$ | | | | | | | | |
| | output voltage | I _O = 20 μA | - | 0 | 0.1 | - | 0.1 | - | 0.1 | V |
| | | $I_0 = 4.0 \text{ mA}$ | - | 0.15 | 0.26 | - | 0.33 | - | 0.4 | V |
| | | | | | | | | | | |

8-stage shift-and-store bus register

| Symbol | Parameter | Conditions | | 25 °C | | –40 °C t | o +85 °C | –40 °C t | o +125 °C | Unit |
|------------------|-----------------------------|---|-----|-------|------|----------|----------|----------|-----------|------|
| | | | Min | Тур | Max | Min | Max | Min | Max | |
| l _l | input leakage current | $V_I = V_{CC} \text{ or GND};$ $V_{CC} = 5.5 \text{ V}$ | - | - | ±0.1 | - | ±1.0 | - | ±1.0 | μA |
| I _{OZ} | OFF-state output current | $V_I = V_{IH}$ or V_{IL} ; $V_{CC} = 5.5$ V; $V_O = V_{CC}$ or GND per input pin; other inputs at V_{CC} or GND; $I_O = 0$ A | - | - | ±0.5 | - | ±5.0 | - | ±10 | μA |
| I _{CC} | supply current | $\label{eq:VI} \begin{array}{l} V_{I} = V_{CC} \text{ or } GND; \ I_{O} = 0 \ A; \\ V_{CC} = 5.5 \ V \end{array}$ | - | - | 8.0 | - | 80 | - | 160 | μA |
| ΔI _{CC} | additional supply current | $\label{eq:VL} \begin{array}{l} V_{I} = V_{CC} - 2.1 \ V; \\ \text{other inputs at } V_{CC} \ \text{or GND}; \\ V_{CC} = 4.5 \ V \ \text{to } 5.5 \ V; \\ I_{O} = 0 \ \text{A} \end{array}$ | | | | | | | | |
| | | per input pin; STR input | - | 100 | 360 | - | 450 | - | 490 | μΑ |
| | | per input pin; OE input | - | 150 | 540 | - | 675 | - | 735 | μΑ |
| | | per input pin; CP input | - | 150 | 540 | - | 675 | - | 735 | μΑ |
| | | per input pin; D input | - | 40 | 144 | - | 180 | - | 196 | μΑ |
| CI | input capacitance | | - | 3.5 | - | | | | | pF |

Table 6. Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

74HC_HCT4094
Product data sheet

8-stage shift-and-store bus register

11. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); $C_L = 50 \text{ pF}$ unless otherwise specified; for test circuit see <u>Figure 12</u>.

| Symbol | Parameter | Conditions | | | 25 °C | | -40 °C | to +85 °C | -40 °C | to +125 °C | Uni |
|---------|--------------------|---|------------|-----|-------|-----|--------|-----------|--------|------------|-----|
| | | | | Min | Тур | Max | Min | Max | Min | Max | - |
| 74HC409 | 94 | | | | | | 1 | I | 1 | | 1 |
| pd | propagation | CP to QS1; see Figure 8 | [1] | | | | | | | | |
| | delay | $V_{CC} = 2.0 V$ | | - | 50 | 150 | - | 190 | - | 225 | ns |
| | | $V_{CC} = 4.5 V$ | | - | 18 | 30 | - | 38 | - | 45 | ns |
| | | $V_{CC} = 5 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$ | | - | 15 | - | - | - | - | - | ns |
| | | $V_{CC} = 6.0 V$ | | - | 14 | 26 | - | 33 | - | 38 | ns |
| | | CP to QS2; see Figure 8 | [1] | | | | | | | | |
| | | $V_{CC} = 2.0 V$ | | - | 44 | 135 | - | 170 | - | 205 | ns |
| | | $V_{CC} = 4.5 V$ | | - | 16 | 27 | - | 34 | - | 41 | ns |
| | | $V_{CC} = 5 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$ | | - | 13 | - | - | - | - | - | ns |
| | | $V_{CC} = 6.0 V$ | | - | 13 | 23 | - | 29 | - | 35 | ns |
| | | CP to QPn; see Figure 8 | [1] | | | | | | | | |
| | | $V_{CC} = 2.0 V$ | | - | 63 | 195 | - | 245 | - | 295 | ns |
| | | $V_{CC} = 4.5 V$ | | - | 23 | 39 | - | 49 | - | 59 | ns |
| | | $V_{CC} = 5 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$ | | - | 20 | - | - | - | - | - | ns |
| | | $V_{CC} = 6.0 V$ | | - | 18 | 33 | - | 42 | - | 50 | ns |
| | | STR to QPn; see Figure 9 | [1] | | | | | | | | |
| | | $V_{CC} = 2.0 V$ | | - | 58 | 180 | - | 225 | - | 270 | ns |
| | | $V_{CC} = 4.5 V$ | | - | 21 | 36 | - | 45 | - | 54 | ns |
| | | $V_{CC} = 5 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$ | | - | 18 | - | - | - | - | - | ns |
| | | $V_{CC} = 6.0 V$ | | - | 17 | 31 | - | 38 | - | 46 | ns |
| en | enable time | OE to QPn; see Figure 11 | [2] | | | | | | | | |
| | | $V_{CC} = 2.0 V$ | | - | 55 | 175 | - | 220 | - | 265 | ns |
| | | $V_{CC} = 4.5 V$ | | - | 20 | 35 | - | 44 | - | 53 | ns |
| | | $V_{CC} = 6.0 V$ | | - | 16 | 30 | - | 37 | - | 45 | ns |
| dis | disable time | OE to QPn; see Figure 11 | [3] | | | | | | | | |
| | | $V_{CC} = 2.0 V$ | | - | 41 | 125 | - | 155 | - | 190 | ns |
| | | $V_{CC} = 4.5 V$ | | - | 15 | 25 | - | 31 | - | 38 | ns |
| | | $V_{CC} = 6.0 V$ | | - | 12 | 21 | - | 26 | - | 32 | ns |
| t | transition time | QPn and QSn; see <u>Figure 8</u> | <u>[4]</u> | | | | | | | | |
| | | $V_{CC} = 2.0 V$ | | - | 19 | 75 | - | 95 | - | 110 | ns |
| | | V _{CC} = 4.5 V | | - | 7 | 15 | - | 19 | - | 22 | ns |
| | | $V_{CC} = 6.0 V$ | | - | 6 | 13 | - | 16 | - | 19 | ns |
| | | | | | | | | | | | |

8-stage shift-and-store bus register

| Symbol | Parameter | Conditions | | 25 °C | | −40 °C | to +85 °C | -40 °C t | o +125 °C | Unit |
|-----------------|-------------------------------------|--|------------|-------|-----|---------------|-----------|----------|-----------|------|
| | | | Min | Тур | Max | Min | Max | Min | Max | |
| t _W | pulse width | CP HIGH or LOW; see <u>Figure 8</u> | | | | 1 | | 1 | 1 | |
| | | $V_{CC} = 2.0 V$ | 80 | 14 | - | 100 | - | 120 | - | ns |
| | | V _{CC} = 4.5 V | 16 | 5 | - | 20 | - | 24 | - | ns |
| | | $V_{CC} = 6.0 V$ | 14 | 4 | - | 17 | - | 20 | - | ns |
| | | STR HIGH; see Figure 9 | | | | | | | | |
| | | $V_{CC} = 2.0 V$ | 80 | 14 | - | 100 | - | 120 | - | ns |
| | | V _{CC} = 4.5 V | 16 | 5 | - | 20 | - | 24 | - | ns |
| | | V _{CC} = 6.0 V | 14 | 4 | - | 17 | - | 20 | - | ns |
| su | set-up time | D to CP; see Figure 10 | | | | | | | | |
| | | V _{CC} = 2.0 V | 50 | 14 | - | 65 | - | 75 | - | ns |
| | | V _{CC} = 4.5 V | 10 | 5 | - | 13 | - | 15 | - | ns |
| | | V _{CC} = 6.0 V | 9 | 4 | - | 11 | - | 13 | - | ns |
| | | CP to STR; see Figure 9 | | | | | | | | |
| | | V _{CC} = 2.0 V | 100 | 28 | - | 125 | - | 150 | - | ns |
| | | V _{CC} = 4.5 V | 20 | 10 | - | 25 | - | 30 | - | ns |
| | | V _{CC} = 6.0 V | 17 | 8 | - | 21 | - | 26 | - | ns |
| h | hold time | D to CP; see Figure 10 | | | | | | | | |
| | | V _{CC} = 2.0 V | 3 | -6 | - | 3 | - | 3 | - | ns |
| | | V _{CC} = 4.5 V | 3 | -2 | - | 3 | - | 3 | - | ns |
| | | V _{CC} = 6.0 V | 3 | -2 | - | 3 | - | 3 | - | ns |
| | | CP to STR; see Figure 9 | | | | | | | | |
| | | V _{CC} = 2.0 V | 0 | -14 | - | 0 | - | 0 | - | ns |
| | | V _{CC} = 4.5 V | 0 | -5 | - | 0 | - | 0 | - | ns |
| | | V _{CC} = 6.0 V | 0 | -4 | - | 0 | - | 0 | - | ns |
| max | maximum | CP; see Figure 8 | | | | | | | | |
| | frequency | V _{CC} = 2.0 V | 6.0 | 28 | - | 4.8 | - | 4.0 | - | MH |
| | | V _{CC} = 4.5 V | 30 | 87 | - | 24 | - | 20 | - | MH |
| | | V _{CC} = 5 V; C _L = 15 pF | - | 95 | - | - | - | - | - | MH |
| | | $V_{CC} = 6.0 V$ | 35 | 103 | - | 28 | - | 24 | - | MH |
| C _{PD} | power dissipation capacitance | $C_L = 50 \text{ pF}; \text{ f} = 1 \text{ MHz};$ $V_I = \text{GND to } V_{CC}$ | <u>[5]</u> | 83 | - | - | - | - | - | pF |

Table 7. Dynamic characteristics ... continued

8-stage shift-and-store bus register

| Symbol | Parameter | Conditions | | | 25 °C | | –40 °C | to +85 °C | -40 °C t | o +125 °C | Unit |
|-----------------|-------------------------------------|--|------------|-----|-------|-----|--------|-----------|----------|-----------|------|
| | | | | Min | Тур | Max | Min | Max | Min | Max | |
| 74HCT40 |)94 | | | | | | | | | | |
| ^t pd | propagation | CP to QS1; see Figure 8 | [1] | | | | | | | | |
| | delay | $V_{CC} = 4.5 V$ | | - | 23 | 39 | - | 49 | - | 59 | ns |
| | | $V_{CC} = 5 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$ | | - | 19 | - | - | - | - | - | ns |
| | | CP to QS2; see Figure 8 | [1] | | | | | | | | |
| | | $V_{CC} = 4.5 V$ | | - | 21 | 36 | - | 45 | - | 54 | ns |
| | | $V_{CC} = 5 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$ | | - | 18 | - | - | - | - | - | ns |
| | | CP to QPn; see Figure 8 | [1] | | | | | | | | |
| | | $V_{CC} = 4.5 V$ | | - | 25 | 43 | - | 54 | - | 65 | ns |
| | | $V_{CC} = 5 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$ | | - | 21 | - | - | - | - | - | ns |
| | | STR to QPn; see Figure 9 | [1] | | | | | | | | |
| | | V _{CC} = 4.5 V | | - | 22 | 39 | - | 49 | - | 59 | ns |
| | | V _{CC} = 5 V; C _L = 15 pF | | - | 19 | - | - | - | - | - | ns |
| en | enable time | OE to QPn; see Figure 11 | [2] | | | | | | | | |
| | | V _{CC} = 4.5 V | | - | 20 | 35 | - | 44 | - | 53 | ns |
| dis | disable time | OE to QPn; see Figure 11 | [3] | | | | | | | | |
| | | V _{CC} = 4.5 V | | - | 21 | 35 | - | 44 | - | 53 | ns |
| t | transition time | QPn and QSn; see Figure 8 | <u>[4]</u> | | | | | | | | |
| | | $V_{CC} = 4.5 V$ | | - | 7 | 15 | - | 19 | - | 22 | ns |
| W | pulse width | CP HIGH or LOW; see <u>Figure 8</u> | | | | | | | | | |
| | | $V_{CC} = 4.5 V$ | | 16 | 7 | - | 20 | - | 24 | - | ns |
| | | STR HIGH; see Figure 9 | | | | | | | | | |
| | | $V_{CC} = 4.5 V$ | | 16 | 5 | - | 20 | - | 24 | - | ns |
| su | set-up time | Dn to CP; see Figure 10 | | | | | | | | | |
| | | $V_{CC} = 4.5 V$ | | 10 | 4 | - | 13 | - | 15 | - | ns |
| | | CP to STR; see Figure 9 | | | | | | | | | |
| | | V _{CC} = 4.5 V | | 20 | 9 | - | 25 | - | 30 | - | ns |
| ĥ | hold time | Dn to CP; see Figure 10 | | | | | | | | | |
| | | V _{CC} = 4.5 V | | 4 | 0 | - | 4 | - | 4 | - | ns |
| | | CP to STR; see Figure 9 | | | | | | | | | |
| | | V _{CC} = 4.5 V | | 0 | -4 | - | 0 | - | 0 | - | ns |
| max | maximum | CP; see Figure 8 | | | | | | | | | |
| | frequency | $V_{CC} = 4.5 V$ | | 30 | 80 | - | 24 | - | 20 | - | MH |
| | | V _{CC} = 5 V; C _L = 15 pF | | - | 86 | - | - | - | - | - | МH |
| C _{PD} | power dissipation capacitance | $C_L = 50 \text{ pF}; f = 1 \text{ MHz};$ $V_I = \text{GND to } V_{CC}$ | [5] | - | 92 | - | - | - | - | - | pF |

Table 7. Dynamic characteristics ... continued

[1] t_{pd} is the same as t_{PLH} and t_{PHL} .

74HC4094; 74HCT4094

8-stage shift-and-store bus register

- [2] t_{en} is the same as t_{PZH} and t_{PZL} .
- [3] t_{dis} is the same as t_{PLZ} and t_{PHZ} .
- [4] t_t is the same as t_{THL} and t_{TLH} .
- [5] C_{PD} is used to determine the dynamic power dissipation (P_D in μ W).

 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \sum (C_L \times V_{CC}^2 \times f_o)$ where:

 f_i = input frequency in MHz;

 f_o = output frequency in MHz;

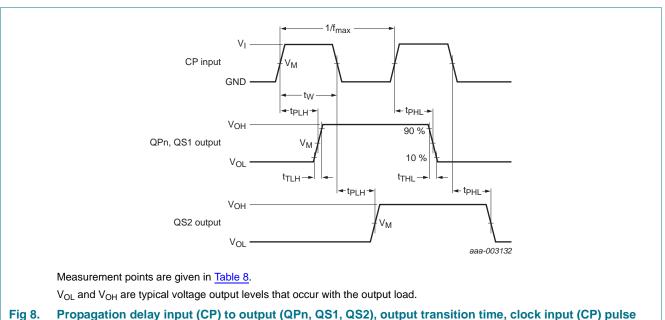
 C_L = output load capacitance in pF;

 V_{CC} = supply voltage in V;

N = number of inputs switching;

 $\Sigma(C_L \times V_{CC}{}^2 \times f_o)$ = sum of outputs.

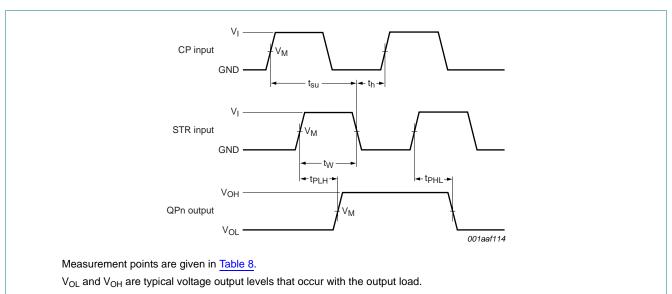
12. Waveforms



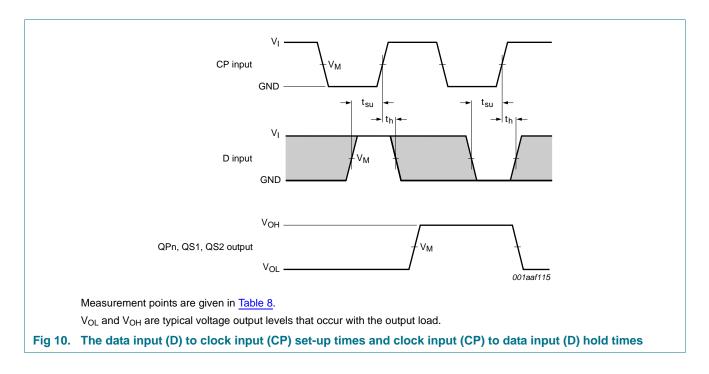
width and the maximum frequency (CP)

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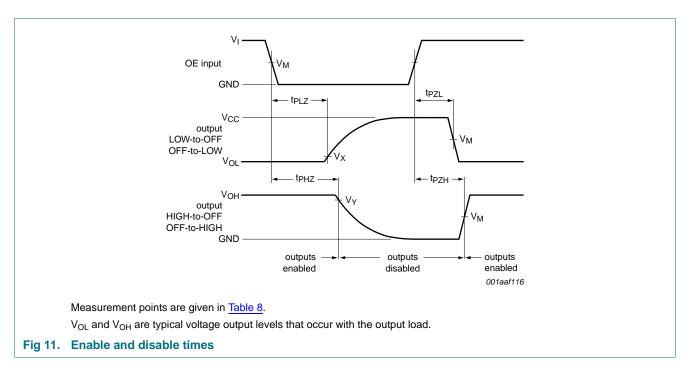


Table 8.Measurement points

| Туре | Input | Output | | |
|-----------|--------------------|--------------------|--------------------|--------------------|
| | V _M | V _M | V _X | V _Y |
| 74HC4094 | 0.5V _{CC} | 0.5V _{CC} | 0.1V _{OH} | 0.9V _{OH} |
| 74HCT4094 | 1.3 V | 1.3 V | 0.1V _{OH} | 0.9V _{OH} |

74HC4094; 74HCT4094

8-stage shift-and-store bus register

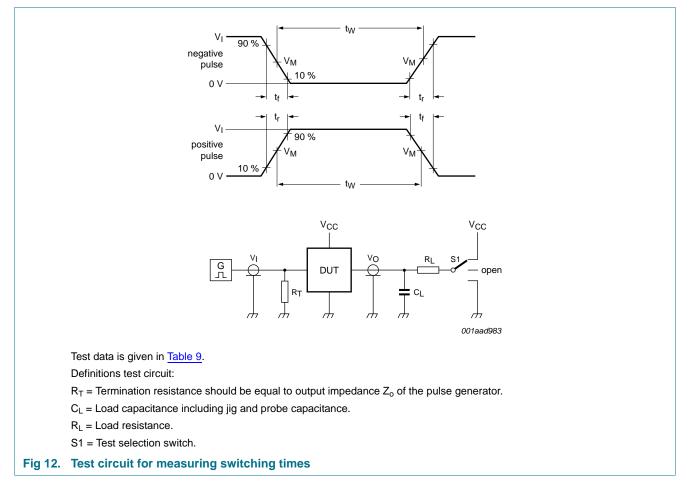


Table 9. Test data

| Туре | Input | | Load | | S1 position | | | |
|-----------|-----------------|---------------------------------|--------------|------|-------------------------------------|-------------------------------------|-------------------------------------|--|
| | VI | t _r , t _f | CL | RL | t _{PHL} , t _{PLH} | t _{PZH} , t _{PHZ} | t _{PZL} , t _{PLZ} | |
| 74HC4094 | V _{CC} | 6 ns | 15 pF, 50 pF | 1 kΩ | open | GND | V _{CC} | |
| 74HCT4094 | 3 V | 6 ns | 15 pF, 50 pF | 1 kΩ | open | GND | V _{CC} | |

8-stage shift-and-store bus register

13. Package outline

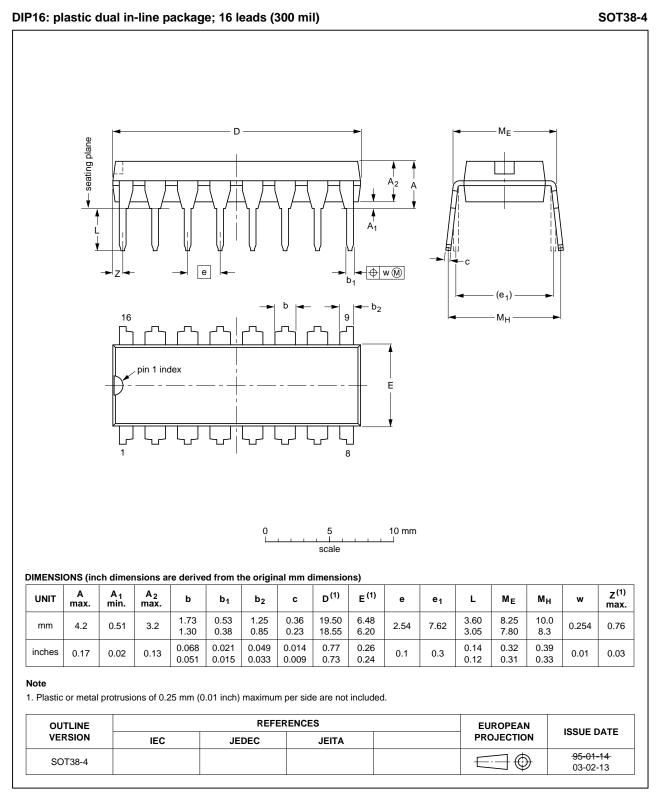


Fig 13. Package outline SOT38-4 (DIP16)

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8-stage shift-and-store bus register

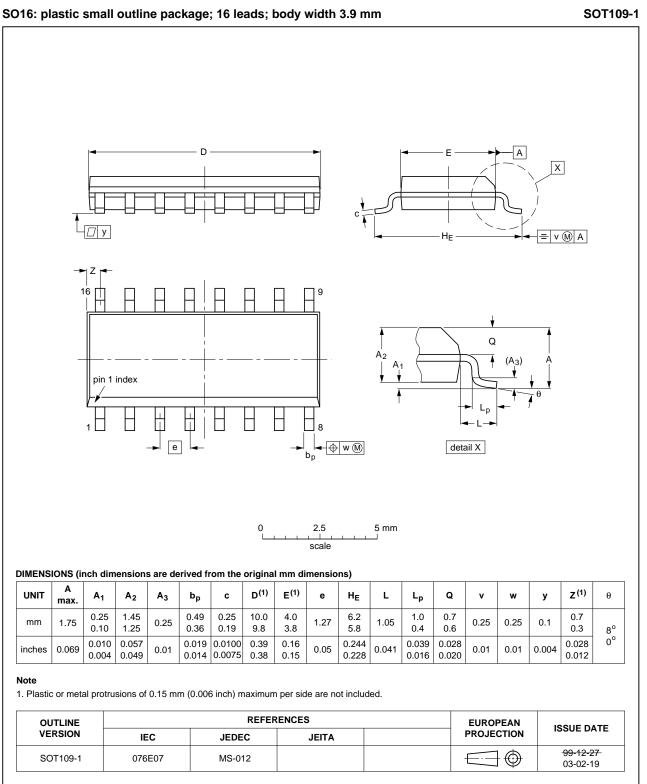


Fig 14. Package outline SOT109-1 (SO16)

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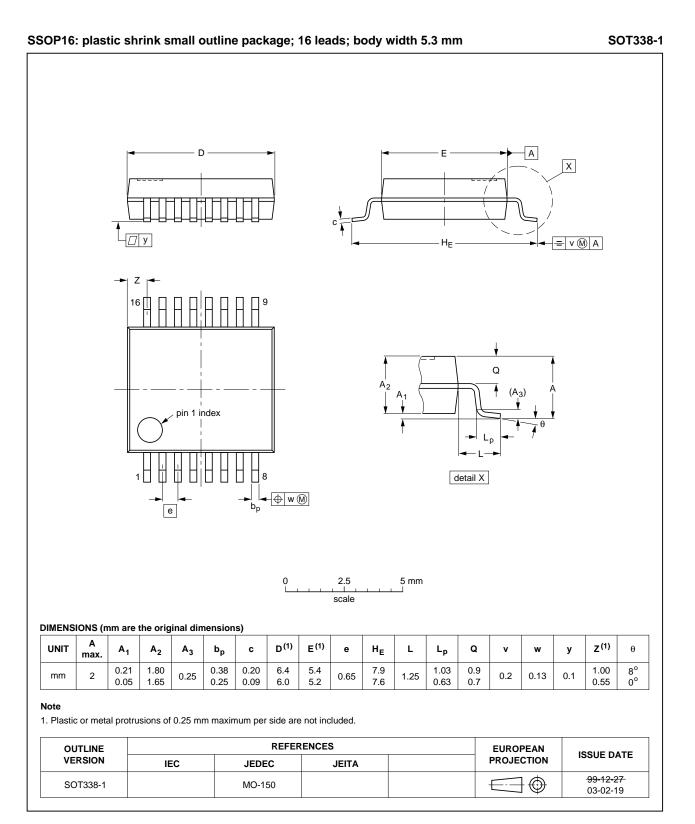


Fig 15. Package outline SOT338-1 (SSOP16)

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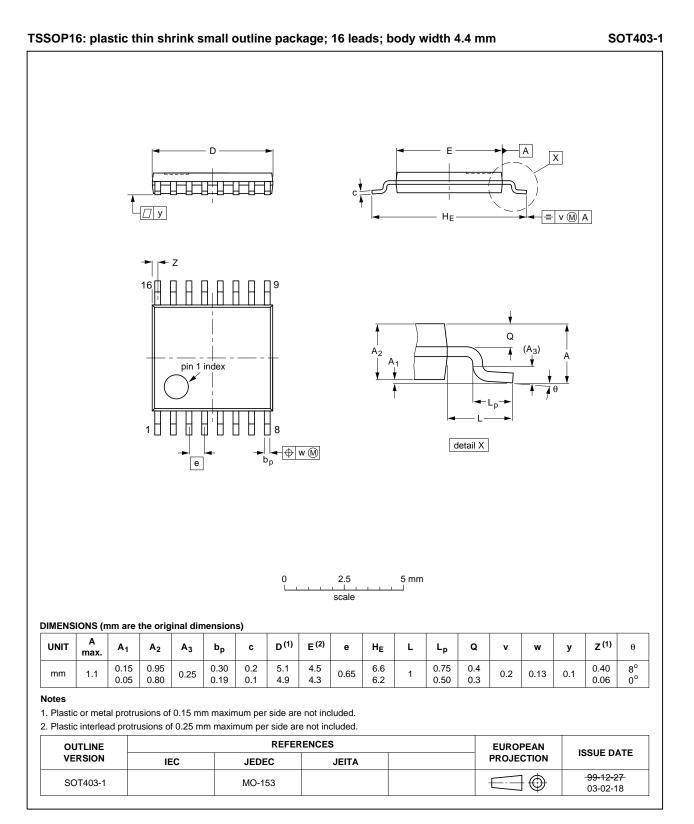


Fig 16. Package outline SOT403-1 (TSSOP16)

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8-stage shift-and-store bus register

14. Abbreviations

| Table 10. Abbreviations | | | | |
|-------------------------|---|--|--|--|
| Acronym | Description | | | |
| CMOS | Complementary Metal Oxide Semiconductor | | | |
| ESD | ElectroStatic Discharge | | | |
| HBM | Human Body Model | | | |
| MM | Machine Model | | | |

15. Revision history

Table 11. Revision history

| Release date | Data sheet status | Change notice | Supersedes | |
|--------------------------------|---|--|--|--|
| 20121231 | Product data sheet | - | 74HC_HCT4094 v.5 | |
| General description updated. | | | | |
| 20120628 | Product data sheet | - | 74HC_HCT4094 v.4 | |
| • V_X and V_Y | measurement points adde | d to Table 8. | | |
| 20111219 | Product data sheet | - | 74HC_HCT4094 v.3 | |
| Legal page | s updated. | | | |
| 20110214 | Product data sheet | - | 74HC_HCT4094_CNV v.2 | |
| 19970901 | Product specification | - | - | |
| | 20121231 • General de 20120628 • V _X and V _Y 20111219 • Legal page 20110214 | 20121231Product data sheet• General description updated.20120628Product data sheet• V _X and V _Y measurement points added20111219Product data sheet• Legal pages updated.20110214Product data sheet | 20121231Product data sheet-• General description updated.20120628Product data sheet-• V _X and V _Y measurement points added to Table 8.20111219Product data sheet-• Legal pages updated.20110214Product data sheet- | |

8-stage shift-and-store bus register

16. Legal information

16.1 Data sheet status

| Document status[1][2] | Product status ^[3] | Definition |
|--------------------------------|-------------------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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18. Contents

| 1 | General description 1 |
|------|------------------------------------|
| 2 | Features and benefits 1 |
| 3 | Applications 1 |
| 4 | Ordering information 2 |
| 5 | Functional diagram 2 |
| 6 | Pinning information 4 |
| 6.1 | Pinning 4 |
| 6.2 | Pin description 4 |
| 7 | Functional description 5 |
| 8 | Limiting values 6 |
| 9 | Recommended operating conditions 6 |
| 10 | Static characteristics 7 |
| 11 | Dynamic characteristics 9 |
| 12 | Waveforms 12 |
| 13 | Package outline 16 |
| 14 | Abbreviations 20 |
| 15 | Revision history 20 |
| 16 | Legal information 21 |
| 16.1 | Data sheet status 21 |
| 16.2 | Definitions |
| 16.3 | Disclaimers 21 |
| 16.4 | Trademarks 22 |
| 17 | Contact information 22 |
| 18 | Contents 23 |

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